







Features

- 0.2 inch digit height
- Robust package
- Low power consumption
- \bullet Standard configuration: Gray face w/ white segments
- Standard Package: 300pcs/ ReelMSL (Moisture Sensitivity Level): 2a
- RoHS Compliant







ATTENTION OBSERVE PRECAUTIONS FOR HANDLING ELECTROSTATIC DISCHARGE

SENSITIVE DEVICES **Package Schematics** 14.1[0.555] 1.44X9=12.96[0.51] 7.2[0.283] 3[0.118] o.8[0.031] ø0.8[0.031] Ø0.6[0.024] 0.1[0.004] +8.1 1.44[0.057] DIG.1: 3,18 0.9[0.035]1 19 20 5 17 16 4 2 DIG.2:8,13

Notes:

- 1. All dimensions are in millimeters (inches), Tolerance is $\pm 0.25 (0.01")$ unless otherwise noted.
- 2. Specifications are subject to change without notice.
- 3. The gap between the reflector and PCB shall not exceed $0.25 \mathrm{mm}$.

Absolute Maximum Ratings (T _A =25°C)	Green (AlGaInP)	Unit	
Reverse Voltage	V_{R}	5	V
Forward Current	I_{F}	30	mA
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	i_{FS}	150	mA
Power Dissipation	P_D	75	mW
Operating Temperature	$T_{\rm A}$	-40 ~ +85	°C
Storage Temperature	Tstg	-40 ~ +85	

A Relative Humidity between 40% and 60% is recommended in ESD-protected work areas to reduce static build up during assembly process (Reference JEDEC/JESD625-A and JEDEC/J-STD-033)

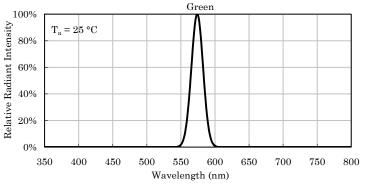
Operating Characteristics (T _A =25°C)		Green (AlGaInP)	Unit
Forward Voltage (Typ.) (I _F =10mA)	V_{F}	2	V
Forward Voltage (Max.) (I _F =10mA)	V_{F}	2.45	V
Reverse Current (Max.) (V _R =5V)	I_R	10	μА
Wavelength of Peak Emission CIE127-2007* (Typ.) (I _F =10mA)	p.) λP 574*		nm
Wavelength of Dominant Emission CIE127-2007* (Typ.) (I _F =10mA)	λD	570*	nm
Spectral Line Full Width At Half-Maximum (Typ.) (I _F =10mA)	$\triangle \lambda$	20	nm
Capacitance (Typ.) (V _F =0V, f=1MHz)	С	15	pF

Part Number	Emitting Color	Emitting Material	Luminous Intensit CIE127-2007* (I_F =10mA) ucd	y Wavelength CIE127-2007* nm λP	Description
			min. typ.		
XZFVG05A2	Green	AlGaInP	3600 11990 2200* 4290*	574*	Common Anode, Rt.Hand Decimal.

^{*}Luminous intensity value and wavelength are in accordance with CIE127-2007 standards. Feb 22.2019

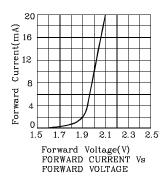


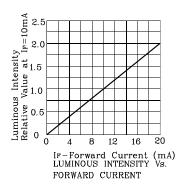


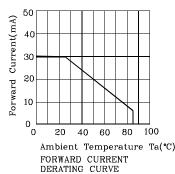


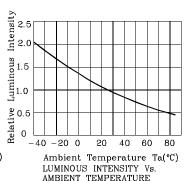
Relative Intensity Vs. CIE Wavelength

Green



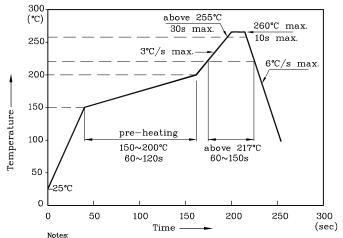






LED is recommended for reflow soldering and soldering profile is shown below.

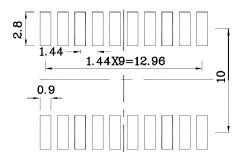
Reflow Soldering Profile for SMD Products (Pb-Free Components)



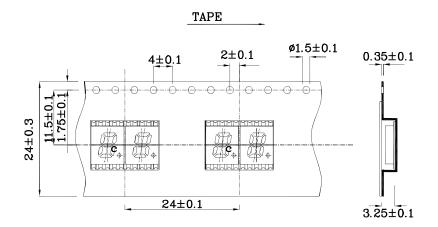
- 1. All temperatures refer to the center of the package,
- measured on the package body surface facing up during reflow. Do not apply any stress to the LED during high temperature conditions.
 Maximum number of soldering passes: 2



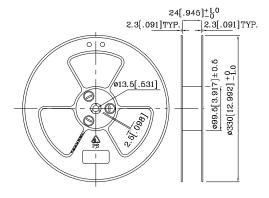
❖ Recommended Soldering Pattern (Units: mm; Tolerance: ±0.15)



* Tape Specification (Units:mm)



* Reel Dimension



Remarks:

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

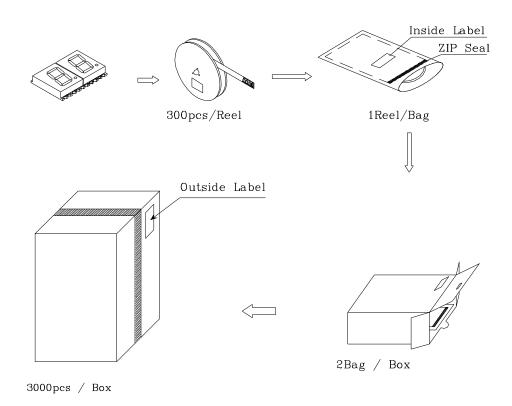
- 1. Wavelength: +/-1nm
- 2. Luminous intensity / luminous flux: +/-15%
- 3. Forward Voltage: +/-0.1V

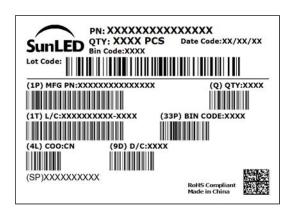
Note: Accuracy may depend on the sorting parameters.





PACKING & LABEL SPECIFICATIONS





TERMS OF USE

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- 2. Contents within this document are subject to improvement and enhancement changes without notice.
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